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 7 Properties of the Interphase Epoxy-Amine/Metal: Influences from the Nature of the Amine and the Metal

## Sommario/riassunto

Emphasizing the most recent developments this book addresses both the basic and applied aspects of adhesion. The authors present the latest results on fundamental aspects, adhesion in biology, chemistry for adhesive formulation, surface chemistry and the pretreatment of adherends, mechanical issues, non-destructive testing and the durability of adhesive joints, as well as advanced technical applications of adhesive joints. Prominent scientists review the current level of knowledge concerning the role of chemical bonds in adhesion, new resins and nanocomposites for adhesives, and about the role